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Connection Diagrams



Figure 1. Pin Assignment for SOIC, SOP, and TSSOP

Figure 2. Pad Assignment for WQFN

74LCX138



NOTE: Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		-0.5 to +6.5	V
Vo	DC Output Voltage (Note 1)	Active-Mode (High or Low State) Tri-State Mode Power-Down Mode (V _{CC} = 0 V)	-0.5 to V _{CC} + 0.5 -0.5 to +6.5 -0.5 to +6.5	V
I _{IK}	DC Input Diode Current	V _I < GND	-50	mA
I _{ОК}	DC Output Diode Current	V _O < GND	-50	mA
Ι _Ο	DC Output Source/Sink Current			

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Тур	Max	Unit
V _{CC}	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	V
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri-State Mode Power Down Mode ($V_{CC} = 0 V$)	0 0 0		V _{CC} 5.5 5.5	V
T _A	Operating Free-Air Temperature		-40	-	+125	°C
t _r , t _f	Input Rise or Fall Rate	$\begin{array}{c} V_{CC} = 1.65 \; V \; to \; 1.95 \; V \\ V_{CC} = 2.3 \; V \; to \; 2.7 \; V \\ V_{IN} \; from \; 0.8 \; V \; to \; 2.0 \; V, \; V_{CC} = 3.0 \; V \\ V_{CC} = 4.5 \; V \; to \; 5.5 \; V \end{array}$		-	-	-



74LCX138





ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
74LCX138BQX	LCX138	WQFN-16 (Pb-Free)	3000 Units / Tape & Reel
74LCX138MX	LCX138	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
74LCX138MTCX	LCX 138	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

WQFN16 3.5x2.5, 0.5P CASE 510CC ISSUE O

DATE 31 AUG 2016

B. DIMENSIONS ARE IN MILLIMETERS.



SOIC-16, 150 mils CASE 751BG ISSUE O

DATE 19 DEC 2008





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DESCRIPTION:	SOIC-16, 150 mils		PAGE 1 OF 1

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DATE 19 SEP 2008





^Ү мв			
°L	MIN.		
A A₁ A₂ b b1 c c1	0.05	د ا	0.95 0.30 0.25 0.20 0.16
E1 C		 0.65 BSC	4.50
E L		6.40 BSC 0.60	0.70
	SEE	VARIATION	s 8'

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